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Featuring superior reliability for smartphones and tablet devices, the Nano-SIM card socket mates seamlessly with standard Nano-SIM as well as specially fitted micro-SIM cards

The continued miniaturization of Subscriber Identity Module (SIM) cards with the introduction of Nano-SIM – a 4th generation SIM card standard - to make PCB space for more electronic components, a larger battery and slimmer phone design, has left micro-SIM card users with existing cards that are too big and too thick to fit standard sized Nano-SIM card sockets. Some users have resorted to trimming their micro-SIM cards to fit the smaller socket but realize their micro-SIM cards are still too thick to fit sockets that accept only standard, 0.67mm height Nano-SIM cards.

Molex has designed a Nano-SIM card socket shell with a 1.30mm profile height to enable use of standard height (0.67mm) Nano-SIM cards as well as the thicker (0.76mm) specially fitted micro-SIM cards. The series is used with a 0.30mm block-style SIM connector (series 78545) to provide a high contact normal force (0.30N) that ensures card-to-socket contact integrity and electrical reliability.

The 3-piece socket design with its separate block-style SIM connector and the ejector tray lowers the risk of SMT warpage especially during high IR-processing temperatures.

This compact set of components comes complete with card polarization and detection, as well as tray-locking features. Removal of SIM card is easy. Simply insert a paper clip (with 0.80mm diameter) into the pin-hole located on the right of the tray cover and the tray ejects instantly.

All parts are halogen-free for environmental sustainability and are shipped in embossed tape-on-reel packaging.

For more information, visit our website at: www.molex.com/link/nanosim.html

Block-style SIM Connector with Nano-SIM Card Socket Shell

(For use with customersupplied ejector tray)

78545 SIM Connector,

Block-style, 0.30mm

height

78790 Nano-SIM Card

Socket Shell, 1.30mm height

Use with Ejector Tray

(customer-supplied, customizable upon

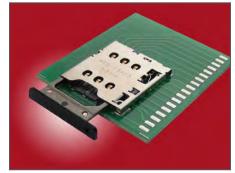
request)



Nano-SIM Card Socket Shell, 1.30mm height (Series 78790)



Block-Style SIM Connector, 0.30mm height (Series 78545)



Recommended assembly with SIM connector and Nano-SIM card socket shell fitted with customer-supplied ejector tray



Features and Benefits

Block-Style SIM Connector (Series 78545)

High Contact Normal Force (0.30N)	Improves card-to-socket (electrical) contact when used with card and socket shell	
0.38micron Gold (Au) on contact and 0.05micron Gold-flash on soldertail	Ensures high connector reliability by providing a stable and low contact resistance over the operating life of applications	
0.30mm connector height	For maximum vertical space savings in low-profile applications	
Rounded geometry of contact terminals	Ensures smooth gliding action of the SIM card during insertion	
Halogen-free, lead-free	For environmental sustainability	

Block-style SIM Connector with Nano-SIM Card Socket Shell

Specifications

Block-Style SIM Connector (Series 78545)

Reference Information

Packaging: Embossed Tape-on-Reel Use With:

Nano-SIM or modified micro-SIM

cards
Terminal Used: Copper Alloy

Designed In: Millimeters

RoHS: Yes Halogen Free: Yes Glow Wire Compliant: No

Electrical

Voltage (max.): 15V DC

Current (max.): 0.5A per contact Low Level Contact Resistance (max.):

100 milliohm initial

Dielectric Withstanding Voltage:

500V AC

Insulation Resistance (min.):

1000 Megohm

Mechanical

Contact Normal Force: (min.) 0.30N Tray Insertion Force with card (min.):

0.30N

Tray Withdrawal Force with card (max.):

20N Solder Joint Peel Strength (min.): 20N

Durability:

240-550 cycles per hour to 500 cycles

Physical

Housing:

LCP, UL94V-0, Glass-filled, Black

Contact: Copper Alloy

Plating:

Contact Area —

0.38μm (15μ") Gold (Au)

Solder Tail Area —

0.05μm (2μ") Gold (Au) Flash

Other Areas —

Nickel (Ni) Plating

Underplating —

2.00μm (μ") Nickel (Ni)

Operating Temperature:

-30 to +85°C



Features and Benefits

Socket Shell (Series 78790)

1.30mm socket shell profile height Accepts both standard 0.67mm Nano-SIM as well as modified, 0.76mm height micro-SIM cards Miniature socket footprint Frees up expensive PCB real estate for maximum space and cost savings Tray lock feature Ensures secure locking of tray when inserted Detect Switch with First-Mate-Last-For reliable tray and SIM card detection Break capability Integral shell tabs and stainless Reinforces soldering hold-down of steel tab on shaft housing socket and housing components Card polarization features Ensure correct card orientation when used with socket

Block-style SIM Connector with Nano-SIM Card Socket Shell

Specifications

Socket Shell (Series 78790)

Reference Information

Packaging: Embossed Tape-on-Reel Use With:

Nano-SIM or modified micro-SIM cards

Terminal Used: Copper Alloy Designed In: Millimeters

RoHS: Yes

Halogen Free: Yes Glow Wire Compliant: No

Electrical

Voltage (max.): 10V DC

Current (max.): 0.5A per contact Low Level Contact Resistance (max.):

100 milliohm initial

Dielectric Withstanding Voltage:

500V AC

Insulation Resistance (min.):

1000 Megohm

Mechanical

Contact Normal Force: (min.) 0.30N
Tray Insertion Force with card (min.):
0.30N

Tray Withdrawal Force with card (max.): 20N

Durability:

1000 cycles at rate of 720 cycles

per hour max.

Physical

Housing: Insert mold, LCP, UL94V-0

Contact: Copper Alloy

Plating

(Detect Spring of 78790 Socket):

Contact Area —

0.127μm (5μ") Gold (Au)

Solder Tail Area —

1.27μm (50μ") Tin (Sn)

Underplating —

1.27μm (50μ") Nickel (Ni)

Plating (Shell of 78790 Socket):

Contact and Soldering Area — 0.025µm (1µ") Gold (Au)

0.025μπ (1μ) σοια (Αα

Underplating —

1.27μm (50μ") Nickel (Ni)

Plating (Shaft of 78790 Socket):

Solder Tail Area —

1.27μm (50μ") Tin (Sn)

Operating Temperature:

-40 to +85°C



Applications

Smartphones and mobile devices

- SIM cards
- Other mobile devices



Tablet PCs



Block-style SIM Connector with

Nano-SIM Card

Socket Shell

Mobile Wi-Fi* devices



Smartphones

Ordering Information

Order No.	Component	Profile Height (mm)	Number of soldering points
78545-0010	Block-style SIM connector, 0.30mm height	0.30mm	6
<u>78790-1001</u>	Nano-SIM card socket shell with detect switch (tray supplied by customer	1.30mm	7

*Wi-Fi is a registered trademark of the Wi-Fi Alliance

www.molex.com/link/nanosim.html



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов:
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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